

"High Frequency Ceramic Solutions"

Preliminary

2.45 / 5.5GHz WLAN Ceramic Diplexer (BPF/BPF type)

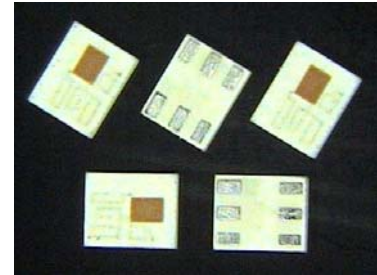
P/N 2450DP39G5500

Detail Specification: 8/2/2012

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General Specifications

Part Number		2450DP39G5500		
Operating Temperature Range		-40 ~ +85 °C		
Frequency	Insertion Loss	Passband VSWR	Return Loss (min)	Attenuation (db)
2400~2500	2.5 max.	2.0 max.	-9.54	30 min. @ 824~915MHz
				30 min. @ 1545~1605MHz
				30 min. @ 1710~1910MHz
				22 min. @ 2170MHz
				35 min. @ 4800~5000MHz
5150~5850	1.0 max.	2.0 max.	-9.54	30 min. @ 7200~7500MHz
				25 min. @ 2400~2500MHz
				20 min. @ 10300~11700MHz



Recommended Storage Conditions*	+5 to +35 °C, Humidity 45~75%RH
Reel Quantity	3,000
Storage Period	18 months max.
Power Capacity	500mW max.

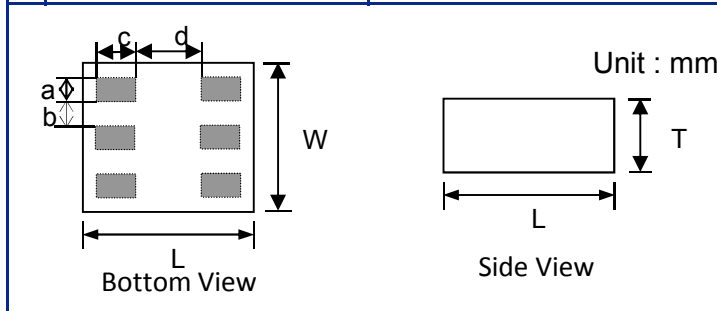
*18 months in vacuum sealed bag and 1 week cumulative after opened.

Part Number Explanation

P/N Suffix	Packing Style	Bulk	Suffix = S	eg. 2450DP39G5500S
		T & R (3000pcs)	Suffix = E	eg. 2450DP39G5500E
		Termination style	Suffix = None	eg. 2450DP39G5500(E or S)
	Evaluation Board	2450DP39G5500-EBSMA		

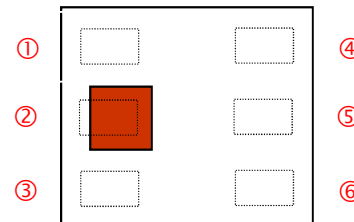
Mechanical Dimensions

	In	mm
L	0.098 ± 0.008	2.50 ± 0.20
W	0.079 ± 0.008	2.00 ± 0.20
T	0.028 max.	0.70 max.
a	0.012 ± 0.004	0.30 ± 0.10
b	0.016 ± 0.004	0.40 ± 0.10
c	0.024 ± 0.004 /-0.2	0.60 ± 0.10
g	0.043 ± 0.006	1.10 ± 0.15



Terminal Configuration

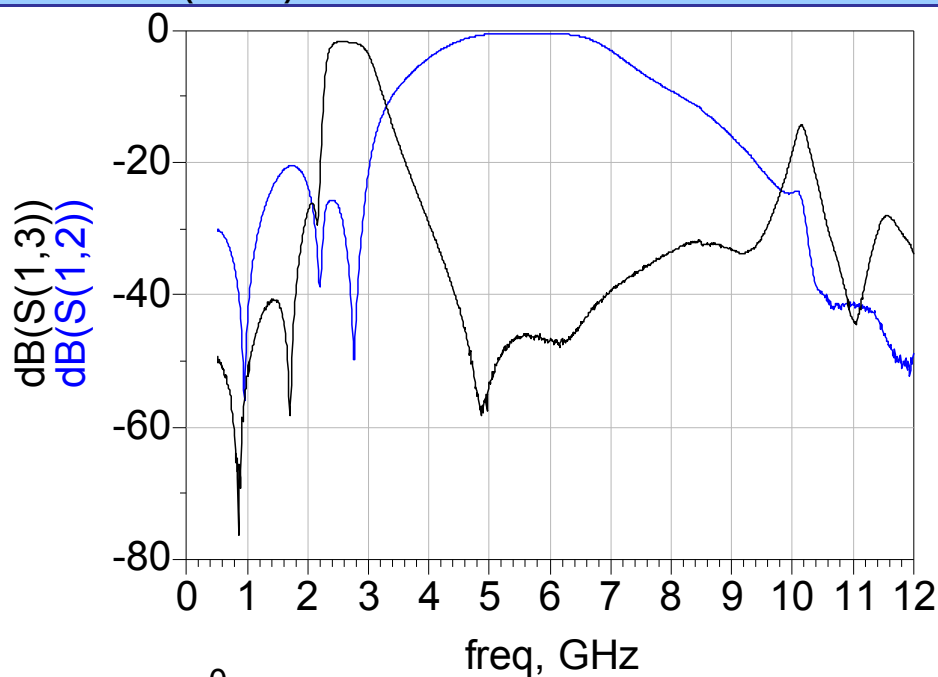
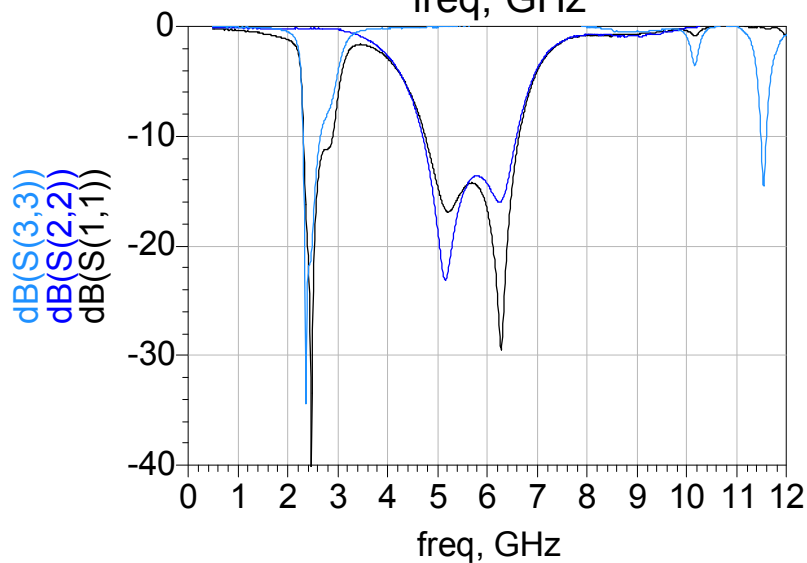
No.	Function
1	GND
2	GND
3	Lower Freq. Port
4	Higher Freq. Port
5	GND
6	Common Port



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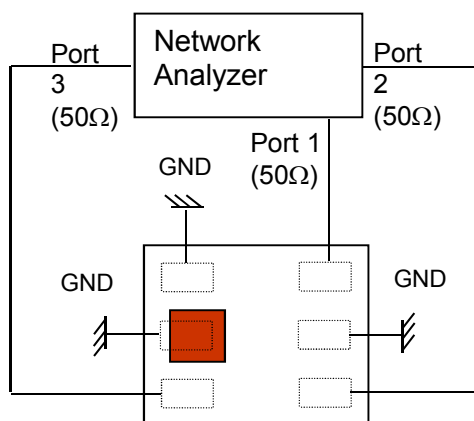
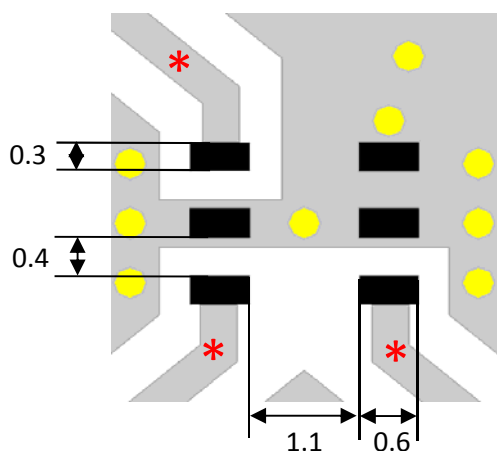
Typical Electrical Performance (T=25°C)**Attenuation****Return Loss**

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Measuring Diagram**Mounting Considerations**

-  Solder Resist
-  Land
-  Through-hole (0.30)

* Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.

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